## DMN2028UFDF

## Product Summary

| BV $V_{\mathrm{DSS}}$ | $\mathbf{R}_{\mathrm{DS}(\mathrm{ON})}$ Max | $\mathbf{I}_{\mathrm{D}}$ Max <br> $\mathbf{T}_{\mathbf{A}}=+\mathbf{+ 2 5} \mathbf{C}$ |
| :---: | :---: | :---: |
| 20 V | $25 \mathrm{~m} \Omega @ \mathrm{~V}_{\mathrm{GS}}=4.5 \mathrm{~V}$ | 7.9 A |
|  | $29 \mathrm{~m} \Omega @ \mathrm{~V}_{\mathrm{GS}}=2.5 \mathrm{~V}$ | 7.2 A |
|  | $39 \mathrm{~m} \Omega @ \mathrm{~V}_{\mathrm{GS}}=1.8 \mathrm{~V}$ | 6.1 A |
|  | $95 \mathrm{~m} \Omega @ \mathrm{~V}_{\mathrm{GS}}=1.5 \mathrm{~V}$ | 4.0 A |

## Description

This MOSFET is designed to minimize the on-state resistance ( $\left.\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}\right)$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

- Battery Management Application
- Power Management Functions
- DC-DC Converters


## Features

- 0.6 mm Profile - Ideal for Low Profile Applications
- PCB Footprint of $4 \mathrm{~mm}^{2}$
- Low Gate Threshold Voltage
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free \& Fully RoHS Compliant (Notes 1 \& 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability


## Mechanical Data

- Case: U-DFN2020-6 (Type F)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 e4)
- Weight: 0.0065 grams (Approximate)


## Ordering Information (Note 4)

| Part Number | Reel Size (inches) | Quantity per Reel |
| :---: | :---: | :---: |
| DMN2028UFDF-7 | 7 | 3,000 |
| DMN2028UFDF-13 | 13 | 10,000 |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) \& 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain $<900 \mathrm{ppm}$ bromine, $<900 \mathrm{ppm}$ chlorine ( $<1500 \mathrm{ppm}$ total $\mathrm{Br}+\mathrm{Cl}$ ) and <1000ppm antimony compounds.
4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## Marking Information



| Year | 2015 |  | 2016 | 2017 |  | 2018 |  | 2019 |  | 2020 | 2021 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Code | C |  | D |  | E | F |  | G |  | H | I |  |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |

Maximum Ratings $\left(@ T_{A}=+25^{\circ} \mathrm{C}\right.$, unless othervise specified.)

| Characteristic |  |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Drain-Source Voltage |  |  | $V_{\text {DSS }}$ | 20 | V |
| Gate-Source Voltage |  |  | $\mathrm{V}_{\text {GSS }}$ | $\pm 8$ | V |
| Continuous Drain Current (Note 6) $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}$ | Steady State | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C} \end{aligned}$ | ID | $\begin{aligned} & \hline 7.9 \\ & 6.3 \\ & \hline \end{aligned}$ | A |
|  | t<5s | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C} \end{aligned}$ | ID | $\begin{aligned} & 9.4 \\ & 7.5 \end{aligned}$ | A |
| Pulsed Drain Current (10 $\mu$ s Pulse, Duty Cycle = 1\%) |  |  | IDM | 40 | A |
| Continuous Source-Drain Diode Current |  | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | Is | 2 | A |
| Avalanche Current (Note 7) L $=0.1 \mathrm{mH}$ |  |  | $\mathrm{I}_{\text {AS }}$ | 12 | A |
| Avalanche Energy (Note 7) L $=0.1 \mathrm{mH}$ |  |  | $\mathrm{E}_{\text {AS }}$ | 8 | mJ |

## Thermal Characteristics

| Characteristic |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Total Power Dissipation (Note 5) | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | PD | 0.66 | W |
|  | $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ |  | 0.42 |  |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady state | $\mathrm{R}_{\text {өJA }}$ | 186 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | t<5s |  | 135 |  |
| Total Power Dissipation (Note 6) | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | PD | 2.03 | W |
|  | $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ |  | 1.31 |  |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady state | $\mathrm{R}_{\text {өJA }}$ | 64 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | t<5s |  | 43 |  |
| Thermal Resistance, Junction to Case (Note 6) | Steady state | $\mathrm{R}_{\text {өJC }}$ | 18 |  |
| Operating and Storage Temperature Range |  | $\mathrm{T}_{\mathrm{J}, \mathrm{T}}$ STG | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

Electrical Characteristics (@T $A=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS (Note 8) |  |  |  |  |  |  |
| Drain-Source Breakdown Voltage | BV ${ }_{\text {DSS }}$ | 20 | - | - | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ |
| Zero Gate Voltage Drain Current $\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}$ | IDSS | - | - | 1 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{DS}}=20 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |
| Gate-Source Leakage | IGSS | - | - | $\pm 10$ | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{GS}}= \pm 8 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |
| ON CHARACTERISTICS (Note 8) |  |  |  |  |  |  |
| Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS}}(\mathrm{TH})$ | 0.5 | - | 1.0 | V | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ |
| Static Drain-Source On-Resistance | $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ | - | 15 | 25 | $\mathrm{m} \Omega$ | $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=4 \mathrm{~A}$ |
|  |  |  | 18 | 29 |  | $\mathrm{V}_{\mathrm{GS}}=2.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=4 \mathrm{~A}$ |
|  |  |  | 24 | 39 |  | $\mathrm{V}_{\mathrm{GS}}=1.8 \mathrm{~V}, \mathrm{l}=4 \mathrm{~A}$ |
|  |  |  | 35 | 95 |  | $\mathrm{V}_{\mathrm{GS}}=1.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=4 \mathrm{~A}$ |
| Forward Transfer Admittance | \| $\mathrm{Y}_{\mathrm{fs}}$ \| | - | 18 | - | S | $V_{D S}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=12 \mathrm{~A}$ |
| Diode Forward Voltage | $\mathrm{V}_{S D}$ | - | 0.7 | 1.0 | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{IS}=5 \mathrm{~A}$ |
| DYNAMIC CHARACTERISTICS (Note 9) |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {iss }}$ | - | 907 | - | pF | $\begin{aligned} & V_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \\ & \mathrm{f}=1.0 \mathrm{MHz} \end{aligned}$ |
| Output Capacitance | $\mathrm{C}_{\text {oss }}$ | - | 98 | - |  |  |
| Reverse Transfer Capacitance | $\mathrm{Crss}^{\text {r }}$ | - | 38 | - |  |  |
| Gate Resistance | $\mathrm{R}_{\mathrm{g}}$ | - | 194 | - | $\Omega$ | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |
| Total Gate Charge (VGS $=4.5 \mathrm{~V}$ ) | $\mathrm{Q}_{\mathrm{g}}$ | - | 9.8 | - | nC | $V_{D S}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=6.5 \mathrm{~A}$ |
| Total Gate Charge ( $\mathrm{V}_{\mathrm{GS}}=8 \mathrm{~V}$ ) | $\mathrm{Q}_{\mathrm{g}}$ | - | 18 | - |  |  |
| Gate-Source Charge | $\mathrm{Q}_{\mathrm{gs}}$ | - | 1.5 | - |  |  |
| Gate-Drain Charge | $\mathrm{Q}_{\mathrm{gd}}$ | - | 1.8 | - |  |  |
| Turn-On Delay Time | tD(ON) | - | 56 | - | ns | $\begin{aligned} & V_{D S}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \\ & R_{G}=6 \Omega, R_{L}=10 \Omega, I_{D}=1 \mathrm{~A} \end{aligned}$ |
| Turn-On Rise Time | $\mathrm{t}_{\mathrm{R}}$ | - | 87 | - |  |  |
| Turn-Off Delay Time | tD(OFF) | - | 632 | - |  |  |
| Turn-Off Fall Time | $\mathrm{t}_{\mathrm{F}}$ | - | 239 | - |  |  |
| Reverse Recovery Time | trR | - | 143 | - | ns | $\mathrm{I}_{\mathrm{F}}=4 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ |
| Reverse Recovery Charge | QRR | -- | 136 | - | nC | $\mathrm{I}_{\mathrm{F}}=4 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ |

Notes: 5. Device mounted on FR-4 substrate PC board, 2 oz copper, with minimum recommended pad layout.
6. Device mounted on FR-4 substrate PC board, 2 oz copper, with 1inch square copper plate.
7. $I_{A S}$ and $E_{A S}$ ratings are based on low frequency and duty cycles to keep $T_{J}=+25^{\circ} \mathrm{C}$.
8. Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to product testing.

## P!PDES




Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage


Figure 5. Typical On-Resistance vs. Drain Current and Temperature


Figure 2. Typical Transfer Characteristic


Figure 4. Typical Transfer Characteristic


Figure 6. On-Resistance Variation with Temperature

## POPES



Figure 7. On-Resistance Variation with Temperature



Figure 11. Gate Charge


Figure 8. Gate Threshold Variation vs. Temperature



DMN2028UFDF


Figure 13. Transient Thermal Resistance

## Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.
U-DFN2020-6 (Type F)


| U-DFN2020-6 (Type F) |  |  |  |
| :---: | :---: | :---: | :---: |
| Dim | Min | Max | Typ |
| A | 0.57 | 0.63 | 0.60 |
| A1 | 0.00 | 0.05 | 0.03 |
| A3 | - | - | 0.15 |
| b | 0.25 | 0.35 | 0.30 |
| D | 1.95 | 2.05 | 2.00 |
| D2 | 0.85 | 1.05 | 0.95 |
| D2a | 0.33 | 0.43 | 0.38 |
| E | 1.95 | 2.05 | 2.00 |
| E2 | 1.05 | 1.25 | 1.15 |
| E2a | 0.65 | 0.75 | 0.70 |
| e | 0.65 BSC |  |  |
| e2 | 0.863 BSC |  |  |
| e3 | 0.70 BSC |  |  |
| e4 | 0.325 BSC |  |  |
| k | 0.37 BSC |  |  |
| k1 | 0.15 BSC |  |  |
| k2 | 0.36 BSC |  |  |
| L | 0.225 | 0.325 | 0.275 |
| z | 0.20 BSC |  |  |
| z1 | 0.110 BSC |  |  |
| z2 | 0.20 BSC |  |  |
| All Dimensions in mm |  |  |  |

## Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

## U-DFN2020-6 (Type F)



| Dimensions | Value <br> (in mm) |
| :---: | :---: |
| $\mathbf{C}$ | 0.650 |
| $\mathbf{X}$ | 0.400 |
| $\mathbf{X 1}$ | 0.480 |
| $\mathbf{X 2}$ | 0.950 |
| $\mathbf{X 3}$ | 1.700 |
| $\mathbf{Y}$ | 0.425 |
| $\mathbf{Y 1}$ | 0.800 |
| $\mathbf{Y 2}$ | 1.150 |
| $\mathbf{Y 3}$ | 1.450 |
| $\mathbf{Y 4}$ | 2.300 |

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